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Vishay/Siliconix IRF9Z20

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Datasheet of IRF9Z20 - MOSFET P-CH 50V 9.7A TO-220AB

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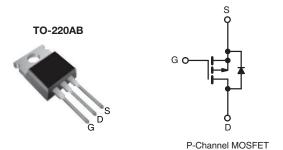


IRF9Z20, SiHF9Z20 www.vishay.com

Vishay Siliconix

Power MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	-5	-50				
R _{DS(on)} (Ω)	V _{GS} = -10 V	0.28				
Q _g max. (nC)	2	6				
Q _{gs} (nC)	6.	2				
Q _{gd} (nC)	8.	8.6				
Configuration	Sin	Single				



FEATURES

- · P-channel versatility
- · Compact plastic package
- Fast switching
- Low drive current
- · Ease of paralleling
- Excellent temperature stability
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

DESCRIPTION

The power MOSFET technology is the key to Vishay's advanced line of power MOSFET transistors. The efficient geometry and unique processing of the power MOSFET design achieve very low on-state resistance combined with high transconductance and extreme device ruggedness.

The P-channel power MOSFETs are designed for application which require the convenience of reverse polarity operation. They retain all of the features of the more common N-channel power MOSFETs such as voltage control, very fast switching, ease of paralleling, and excellent temperature stability.

P-channel power MOSFETs are intended for use in power stages where complementary symmetry with N-channel devices offers circuit simplification. They are also very useful in drive stages because of the circuit versatility offered by the reverse polarity connection. Applications include motor control, audio amplifiers, switched mode converters, control circuits and pulse amplifiers.

ORDERING INFORMATION				
Package	TO-220AB			
Lead (Pb)-free	IRF9Z20PbF			

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V_{DS}	-50	V	
Gate-Source Voltage			V_{GS}	± 20		
Continuous Drain Current	V at 10 V	$T_{\rm C} = 25 ^{\circ}{\rm C}$ $T_{\rm C} = 100 ^{\circ}{\rm C}$	· I _D	-9.7	А	
	V _{GS} at - 10 V	T _C = 100 °C		-6.1		
Pulsed Drain Current ^a			I _{DM}	-39		
Linear Derating Factor				0.32	W/°C	
Inductive Current, Clamped	L = 100 µH		I_{LM}	-39	А	
Unclamped Inductive Current (Avalanche current)			ΙL	-2.2	Α	
Maximum Power Dissipation	T _C = 25 °C		P_{D}	40	W	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	00	
Soldering Recommendations (Peak temperature) ^c	for 10 s		_	300	°C	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 14).
- b. V_{DD} = 25 V, starting T_J = 25 °C, L =100 μH , R_g = 25 Ω
- c. 0.063" (1.6 mm) from case.



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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	80		
Case-to-Sink, Flat, Greased Surface	R _{thCS}	1.0	-	°C/W	
Maximum Junction-to-Case (Drain)	R _{thJC}	-	3.1		

SPECIFICATIONS ($T_J = 25 ^{\circ}C$,	unless othe	rwise noted)					
PARAMETER	SYMBOL	TE	MIN.	TYP.	MAX.	UNIT	
Static		-					•
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_{D} = -250 \mu\text{A}$		-50	-	-	V
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS}	$V_{DS} = V_{GS}, I_{D} = -250 \mu\text{A}$		-	-4.0	V
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 20 V		-	± 500	nA
Zava Cata Valtaria Duais Cumunt	1	V _{DS} =	V _{DS} = max. rating, V _{GS} = 0 V		-	-250	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = max. rati	$mg \times 0.8, V_{GS} = 0 \text{ V}, T_{J} = 125^{\circ}\text{C}$	-	-	-1000	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = -10 V	I _D = -5.6 A ^b	-	0.20	0.28	Ω
Forward Transconductance	9 _{fs}	V _{DS} = 2 x V _{GS} , I _{DS} = -5.6 A ^b		2.3	3.5	-	S
Dynamic							
Input Capacitance	C _{iss}	$V_{GS} = 0 V$,		-	480	-	pF
Output Capacitance	C _{oss}		$V_{DS} = -25 V$,		320	-	
Reverse Transfer Capacitance	C _{rss}	f = 1.0 MHz, see fig. 9		-	58	-	
Total Gate Charge	Q_g	V _{GS} = -10 V	$I_D = -9.7 \text{ A}, V_{DS} = -0.8 \text{ max.}$ rating. see fig. 17	-	17	26	nC
Gate-Source Charge	Q _{gs}			-	4.1	6.2	
Gate-Drain Charge	Q_{gd}			-	5.7	8.6	
Turn-On Delay Time	t _{d(on)}	V	= -25 V, I _D = -9.7 A,	-	8.2	12	
Rise Time	t _r		$V_{DD} = -23 \text{ V, } I_D = -9.7 \text{ A,}$ $R_q = 18 \Omega, R_D = 2.4 \Omega, \text{ see fig. 16 (MOSFET)}$		57	86	ns
Turn-Off Delay Time	t _{d(off)}	switching times are essentially independent of operating temperature)		-	12	18	
Fall Time	t _f			-	25	38	
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	nH
Internal Source Inductance	L _S			-	7.5	-	
Drain-Source Body Diode Characterist	ics						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	-9.7	
Pulsed Diode Forward Current ^a	I _{SM}			-	-	-39	А
Body Diode Voltage	V_{SD}	$T_J = 25 ^{\circ}\text{C}, I_S = -9.7 \text{A}, V_{GS} = 0 \text{V}^{ \text{b}}$		-	-	-6.3	V
Body Diode Reverse Recovery Time	t _{rr}	$T_J = 25 ^{\circ}\text{C}, I_F = -9.7 \text{A}, \text{dI/dt} = 100 \text{A/}\mu\text{s}^{ \text{b}}$		56	110	280	ns
Body Diode Reverse Recovery Charge	Q _{rr}			0.17	0.34	0.85	μC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L _S and L _D)				D)	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 14).
- b. Pulse width \leq 300 μ s; duty cycle \leq 2 %.

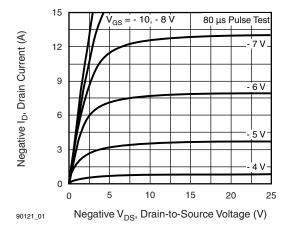




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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



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Fig. 1 - Typical Output Characteristics

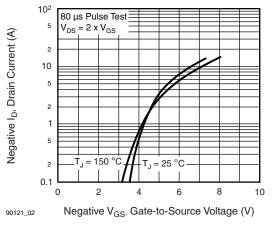


Fig. 2 - Typical Transfer Characteristics

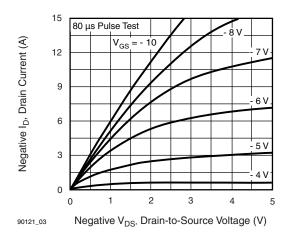


Fig. 3 - Typical Saturation Characteristics

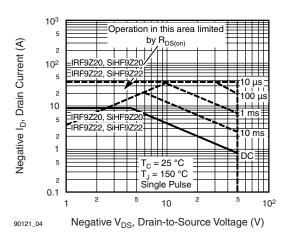


Fig. 4 - Maximum Safe Operating Area

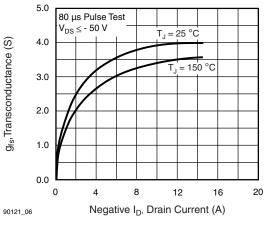


Fig. 5 - Typical Transconductance vs. Drain Current

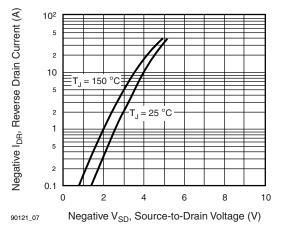


Fig. 6 - Typical Source-Drain Diode Forward Voltage

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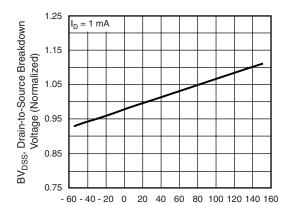
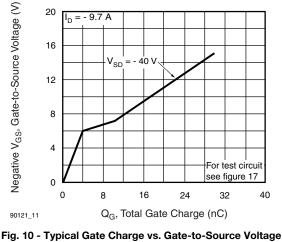


Fig. 7 - Breakdown Voltage vs. Temperature

T_J, Junction Temperature (°C)



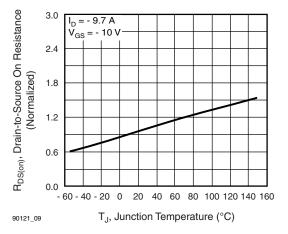


Fig. 8 - Normalized On-Resistance vs. Temperature

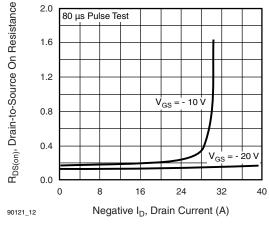


Fig. 11 - Typical On-Resistance vs. Drain Current

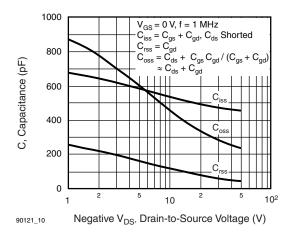


Fig. 9 - Typical Capacitance vs. Drain-to-Source Voltage

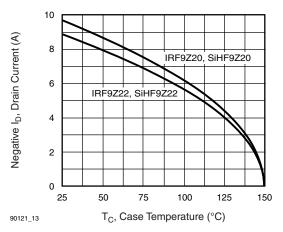


Fig. 12 - Maximum Drain Current vs. Case Temperature

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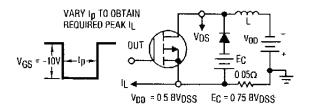
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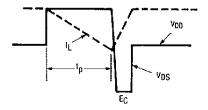


Fig. 13a - Unclamped Inductive Test Circuit

Fig. 13b - Unclamped Inductive Load Test Waveforms

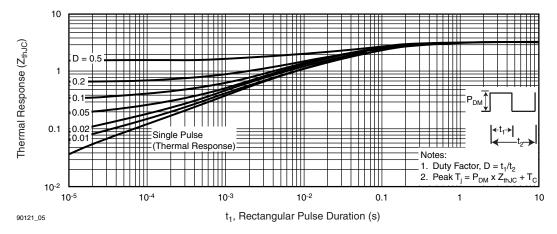


Fig. 14 - Maximum Effective Transient Thermal Impedance, Junction-to-Case vs. Pulse Duration

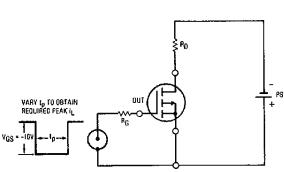


Fig. 15 - Switching Time Test Circuit

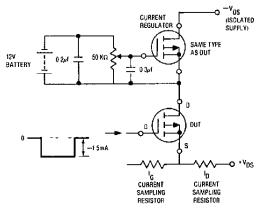


Fig. 16 - Gate Charge Test Circuit

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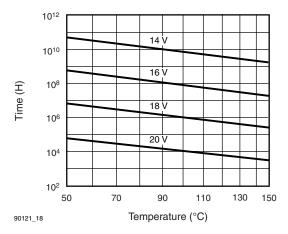


Fig. 17 - Typical Time to Accumulated 1 % Gate Failure

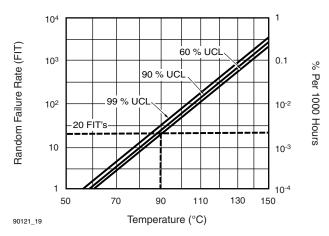


Fig. 18 - Typical High Temperature Reverse Bias (HTRB) Failure Rate

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